



- Designed for SDARS Receiver IF Application
- Low Insertion Loss
- 5.0 X 7.0 mm Surface-Mount Case
- Differential Input and Output
- Complies with Directive 2002/95/EC (RoHS)

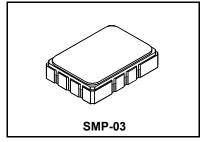


Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Max. DC voltage between any 2 terminals	30	VDC
Storage Temperature Range	-40 to +105	°C
Suitable for lead-free soldering - Max Soldering Temperature	260°C for 30 s	

SF2025B

259.861 MHz SAW Filter



Electrical Characteristics

Characteristic		Notes	Min	Тур	Max	Units
Nominal Center Frequency		1	259.861		MHz	
Passband Minimum Insertion Loss	IL	'		13.3	15.5	dB
1.5 dB Passband	BW _{1.5}			13.8		MHz
3 dB Passband	BW ₃			14.5		IVII IZ
Amplitude Ripple from fc-6.354 MHz to fc-4.2885 MHz (-20 to 85°C)					1	
Amplitude Ripple from fc-6.354 MHz to fc-4.2885 MHz (-40 to -20°C)					1.5	
Amplitude Ripple from fc-4.4965 MHz to fc-2.431 MHz					1	
Amplitude Ripple from fc-2.639 MHz to fc+0.079 MHz					1	dB _{P-P}
Amplitude Ripple from fc-0.079 MHz to fc+2.639 MHz		1, 2			1	
Amplitude Ripple from fc+2.431 MHz to fc+4.4965 MHz					1	
Amplitude Ripple from fc+4.2885 MHz to fc+6.354 MHz (-40 to 60°C)					1	
Amplitude Ripple from fc+4.2885 MHz to fc+6.354 MHz (60 to 85°C)					1.15	1
Group Delay Variation over fc-6.354 MHz to fc-2.431 MHz				40	60	
and from fc+2.431 MHz to fc+6.354 MHz	GDV1			40	00	ns _{P-P}
Group Delay Variation over fc±2.639 MHz	GDV2			40	120	
Rejection fc-28 to fc-12 MHz and fc+12 to fc+33 MHz			36	43		
fc-12 to fc-10.5 MHz		1, 2, 3	30	40		dB
fc+9 to fc+12 MHz			18	36		
Operating Temperature Range		1	-40		+85	°C
Frequency Temperature Coefficeint				-18		ppm/°C
Differential Input and Output Impedance			L & C Mat	tch to 150 ohms	3	•
Case Style		6 SMP-03 7 x 5 mm Nominal Footprin		orint		
Lid Symbolization (YY=year, WW=week, S=shift) See note 4		J		RFM SF2025	B YYWWS	

Electrical Connections

Connection	Terminals
Port 1 Hot	10
Port 1 Ground Return	1
Port 2 Hot	5
Port 2 Ground Return	6
Case Ground	All Others



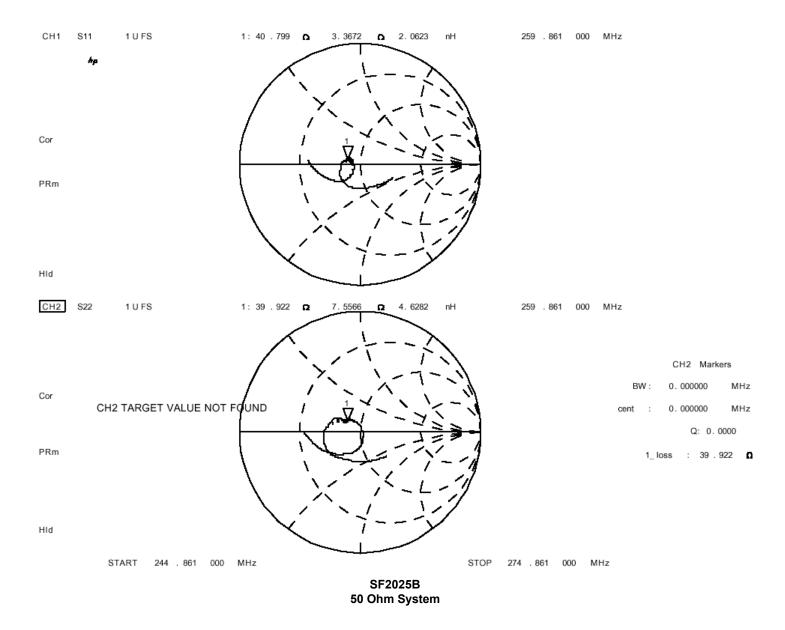
CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

Notes:

- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
- Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
- Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
- "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
- 6. 7.
- The design, manufacturing process, and specifications of this filter are subject to change.

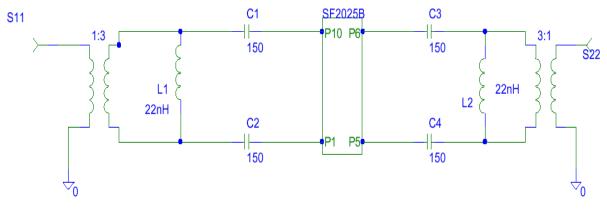
 Tape and Reel Standard Per ANSI / EIA 481.

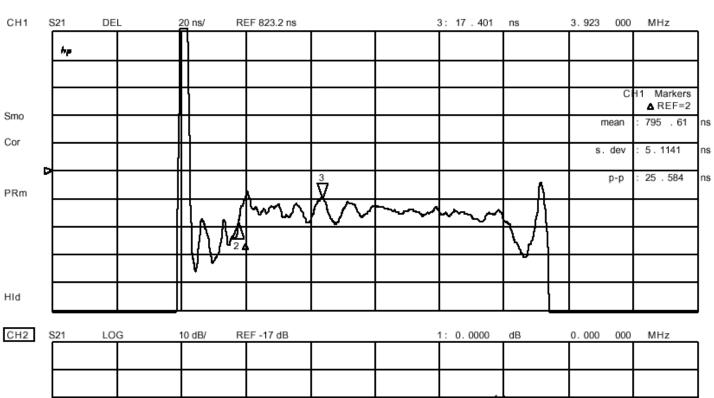
 Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
- US and international patents may apply.
- Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

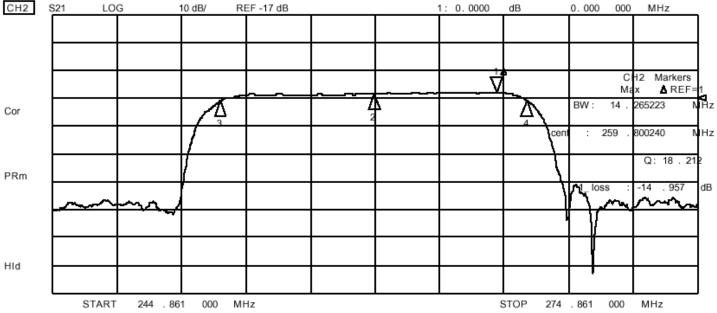


Discontinued

Matching Circuits



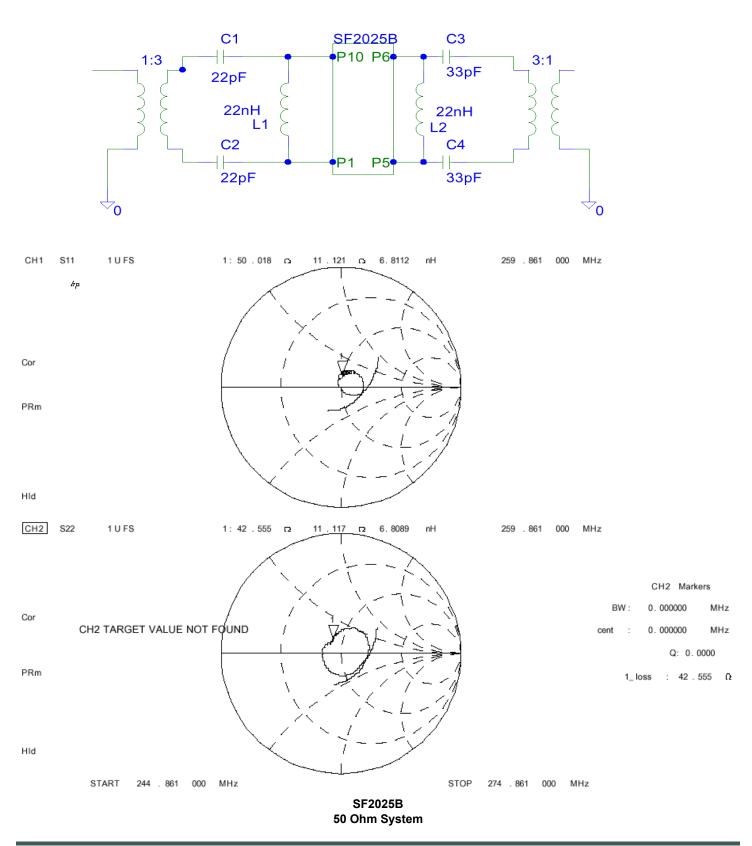




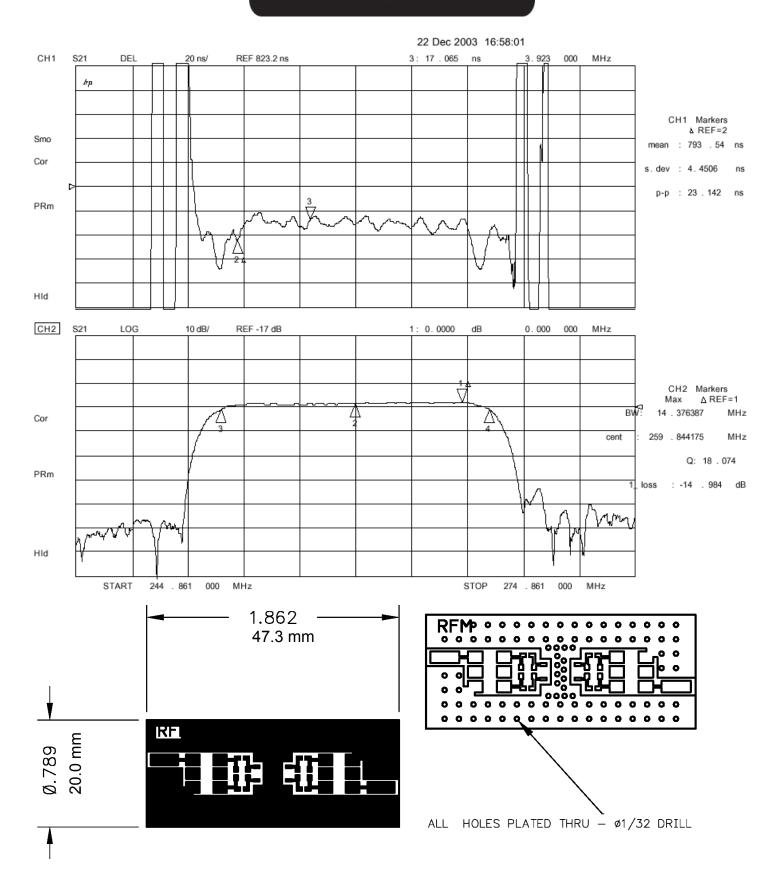
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Matching Circuits

better rejection tuning



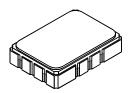
Discontinued



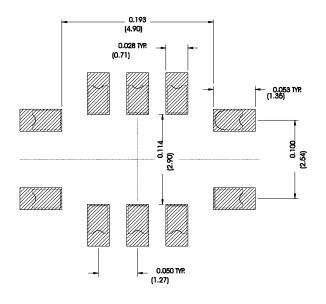
Discontinued '

SMP-03 Case

10-Terminal Ceramic Surface-Mount Case 7 x 5 mm Nominal Footprint



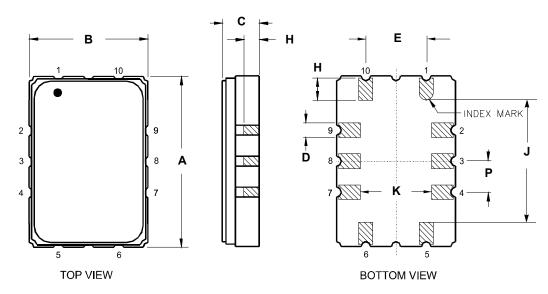
Recommended PCB Footprint



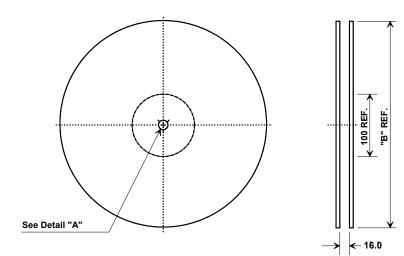
Case Dimensions						
Dimension	mm		Inches			
	Min	Nom	Max	Min	Nom	Max
Α	6.80	7.00	7.20	0.268	0.276	0.283
В	4.80	5.00	5.20	0.189	0.197	0.205
С		1.65	2.00		0.065	0.079
D	.47	0.60	.73	0.019	0.024	0.029
E	2.41	2.54	2.67	0.095	0.100	0.105
Н	0.87	1.0	1.13	0.034	0.039	0.044
J	4.87	5.00	5.13	0.192	0.197	0.202
K	2.87	3.00	3.13	0.113	0.118	0.123
Р	1.14	1.27	1.40	0.045	0.050	0.055

Materials				
Solder Pad Termination	Au plating 30 - 60 μinches (76.2-152 μm) over 80- 200 μinches (203-508 μm) Ni.			
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 µinches Thick			
Body	Al ₂ O ₃ Ceramic			
Pb Free				

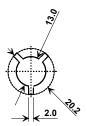
Electrical Connections				
	Connection	Terminals		
Port 1	Input or Return	10		
	Return or Input	1		
Port 2	Output or Return	5		
	Return or Output	6		
	Ground	All others		
Single Ended Operation		Return is ground		
Differential Operation		Return is hot		



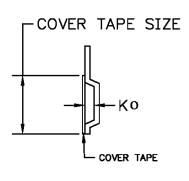
Tape and Reel Specifications



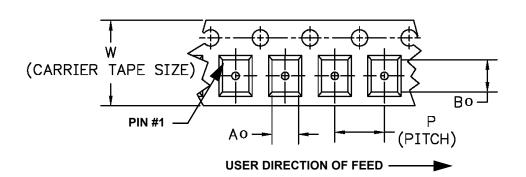
"B " Nominal Size		Quantity Per Reel	
Inches	millimeters		
7	178	500	
13	330	2000	



COMPONENT ORIENTATION and DIMENSIONS



Carrier Tape Dimensions	
Ao	5.5 mm
Во	7.5 mm
Ко	2.0 mm
Pitch	8.0 mm
W	16.0 mm



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